Overview

HP ProBook x360 11 G5 EE



- 1. Webcam LED
- 2. 720p Webcam or optional HP Privacy Camera
- 3. Microphone
- 4. ClickPad
- 5. World-facing 5 Megapixels Webcam (Optional)

Left

- 6. World-facing Webcam LED (Optional)
- 7. Power Button
- 8. Headphone / Microphone Combo Jack
- 9. USB 3.1 Gen 1 Port
- 10. Security Lock Slot (Nano lock sold seperately)



Overview



- 1. Power Connector
- 2. Ethernet (RJ-45) Port
- 3. HDMI Port (Cable not included)

Right

- 4. USB 3.1 Gen 1 Port
- 5. USB Type-C™ (Data and Power in-out)



Overview

AT A GLANCE

- Starting at 3.16 lbs (1.44 kg) touch
- At 21 mm (0.83"), this flexible 360° hinge converts to laptop, tablet, tent, stand or book mode easily
- Designed to pass MIL-STD 810G testing¹ with rugged features such as co-molded rubber trim, spill- and pick-resistant keyboard, and Corning® Gorilla® Glass 3 touch screen
- Optional dual camera system for project-based learning
- New optional active HP Pro Pen is engineered for the classroom durable tips require less replacing
- Pre-installed with Windows 10 Pro 64, Windows 10 Pro 64 (National Academic), Windows 10 Home 64, or Windows 10 Pro in S mode 64, FreeDOS²
- Powered by Intel® Celeron® N4000, Intel® Celeron® N4100 and Intel® Pentium® N4020, N4120 and Pentium N5000, N5030 processors
- Choice of 29.4cm (11.6") diagonal HD UWVA slim LED touch screen (1366 x 768) or 29.4 cm (11.6") diagonal HD SVA slim LED touch screen (1366 x 768) displays
- 64 GB eMMC, 128 GB SATA-3 TLC Solid State Drive or up to 256 GB SATA-3 Solid State Drive storage options
- Up to 8 GB system memory for enhanced memory management
- Reliable connectivity with choice of Intel® Dual Band Wireless-AC 9560 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 5.0 Combo WLAN or Intel® Dual Band Wireless-AX200 802.11a/b/g/n/ax (2x2) Wi-Fi 6 and Bluetooth® 5.0 Combo WLAN for learning and collaboration beyond the classroom
- Built-in ports include: Ethernet (RJ-45), 2 USB 3.1 Gen 1, USB Type-C™, and HDMI 1.4b port for connecting to highresolution displays
- Enhanced security TPM 2.0 discrete chip
- Battery life Up to 16 hours and 45 minutes³
 - 1. MIL STD 810H testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.
 - 2. FreeDOS planned to be available March 2020.
 - 3. Recharges the battery up to 90% within 90 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAME

HP ProBook x360 11 G5 EE

OPERATING SYSTEM

Preinstalled Windows 10 Pro 64¹

Windows 10 Pro 64 (National Academic only)2

Windows® 10 Home 641

Windows 10 Home Single Language 641

Windows 10 Pro in S mode 643

Windows 10 Pro in S mode 64 (National Academic only)^{2,3}

Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)¹

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.
- 3. Windows 10 Pro in S mode 64 works exclusively with apps from the Windows store. Some accessories and apps compatible with Windows 10 may not work, and performance may vary. Certain default settings, features, and apps cannot be changed. Easily switch to Windows 10 Pro configuration (fee applies) Learn more at Microsoft.com/Windows 10S.

PROCESSORS

Intel® Pentium® Silver N5000 with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 2.7 GHz burst frequency, 4 MB cache, 4 cores)^{4,5,6}

Intel® Celeron® N4100 with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.4 GHz burst frequency, 4 MB cache, 4 cores)^{4,5,6}

Intel® Celeron® N4000 with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.6 GHz burst frequency, 4 MB cache, 2 cores)^{4,5,6}

Intel® Pentium® Silver N5030 with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 3.1 GHz burst frequency, 4 MB cache, 4 cores)^{4,5,6}

Intel® Celeron® N4020 with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.8 GHz burst frequency, 4 MB cache, 2 cores)4,5,6

Intel® Celeron® N4120 with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.6 GHz burst frequency, 4 MB cache, 4 cores)4,5,6

Processors Family

Intel® Celeron® processor (N4000, N4020, 4120)⁶ Intel® Pentium® Silver processor (N5000, N5030)⁶

- 4. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 5. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



Technical Specifications **CHIPSET**

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® UHD Graphics 605 (for Pentium Silver)⁷ Intel® UHD Graphics 600 (for Celeron)⁷

7. HD content required to view HD images

DISPLAY

Internal

Touch

29.46 cm (11.6") diagonal HD SVA eDP WLED-backlit touch screen with HD camera, 220 nits, 45% NTSC (1366 x 768) 7,8,9 29.46 cm (11.6") diagonal HD IPS eDP WLED-backlit touch screen with HD camera, 220 nits, 50% NTSC (1366 x 768) 7,8,9

HDMI

Port supports resolutions up to 3840 x 2160 external resolution @30 Hz

- 7. HD content required to view HD images.
- 8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 9. Sold separately or as an optional feature.

STORAGE AND DRIVES

Primary Storage M.2

128 GB SATA-3 TLC Solid State Drive^{10,11} 256 GB SATA-3 TLC Solid State Drive^{10,11}

eMMC Configurations

64 GB eMMC10

10. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

11. Not available with eMMC storage.



Technical Specifications

MEMORY

Standard Maximum Memory 8 GB DDR4-2400 SDRAM¹²

Memory

4 GB DDR4-2400 SDRAM (on-board)¹² 8 GB DDR4-2400 SDRAM (on-board)¹²

12. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Intel® Dual Band Wireless-AC 9560 802.11a/b/g/n/ac (2x2) Wi-Fi® and Bluetooth® 5 Combo, non-vPro™13 Intel® Dual Band Wireless-AX200 802.11a/b/g/n/ax (2x2) Wi-Fi 6 and Bluetooth® 5 Combo, non-vPro™ *

Miracast

Native Miracast Support14

Ethernet

Realtek RTL8111HSH-CG 10/100/1000 GbE NIC15

- 13. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

 14. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.
- 15. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.
- *Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.



AUDIO/MULTIMEDIA

Audio

HP HD Audio 2 Integrated stereo speakers

Camera

User-facing 720p HD camera^{7,16} Located on display

Webcam

World-facing 5 MP secondary camera (Optional)7,9,16

- 7. HD content required to view HD images.
- 9. Sold separately or as an optional feature.
- 16. Internet access required.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS/PEN

Kevboard

Full-sized chiclet keyboard, pick proof

Pointing Device

Clickpad with multi-touch gesture support, taps enabled as default Default on: 2-finger scroll, pinch Support Windows 10 modern Trackpad gestures

Function Keys

- F1 Blank
- F2 Blank
- F3 Sleep
- F4 Display Switching
- F5 Audio Mute/Unmute
- F6 Volume <down>
- F7 Volume <up>
- F8 Mic Mute/Unmute
- F9 Brightness <down>
- F10 Brightness <up>
- F11 Blank
- F12 Wireless On/Off

Pen

Optional Passive Targus Slim Stylus*
Optional Active HP Pro Pen

Sensors

Combo Chip Accelerometer Magnetometer Gyroscope



Technical Specifications

Hall Sensor

*Optional Passive Targus Slim Stylus

SOFTWARE AND SECURITY

Pre-boot Authentication

BIOS

HP BIOSphere Gen5¹⁷
HP Drive Lock & Automatic Drive Lock¹⁸
BIOS Update via Network
Master Boot Record Security
Power On Authentication
Secure Erase¹⁹
Absolute Persistence Module²⁰

Software

HP Connection Optimizer
HP School Pack
HP Interactive Light
HP Image Assistant
HP Hotkey Support
HP JumpStart
HP Support Assistant²¹
HP Noise Cancellation Software

Manageability Features

Buy Office (sold separately)

HP Driver Packs²²
HP System Software Manager (SSM)
HP BIOS Config Utility (BCU)
HP Client Catalog
HP Manageability Integration Kit Gen3²³

Client Security Software

HP Client Security Manager Gen5²⁴ Windows Defender²⁵

Security Management

Pre-boot Authentication
TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)²⁶
USB enable/disable (via BIOS)
Power-on password (via BIOS)
Setup password (via BIOS)
Support for chassis padlocks and cable lock devices
HP Sure Click²⁷

17. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.

18. HP Drive Lock & Automatic Drive Lock is not supported on NVMe drives

19. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

20. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms



Technical Specifications

ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

- 21. HP Support Assistant requires Windows and Internet access.
- 22. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 23. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 24. HP Client Security Manager Gen5 requires Windows and is available on the select HP Pro and Elite PCs. See product specifications for details.
- 25. Windows Defender Opt in and internet connection required for updates.
- 26. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).
- 27. HP Sure Click is available on select HP platforms and supports Microsoft® Internet Explorer, Google Chrome, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode. Check http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW for all compatible platforms as they become available.

POWER

Power Supply

HP Smart 45 W External AC power adapter²⁸ HP Smart 65 W EM External AC power adapter²⁸ HP Smart 45 W USB Type-C™ adapter²⁸

Primary Battery

HP Long Life 3-cell, 48 Wh Li-ion (90% in 90 minutes)^{29,30}

Power Cord

3-wire plug - 1m

Battery life

Up to 16 hours and 45 minutes³¹

- 28. Availability may vary by country.
- 29. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 30. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.
- 31. Recharges the battery up to 90% within 90 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.



WEIGHTS & DIMENSIONS

Product Weight

Starting at 3.16 lb³² Starting at 1.44 kg³²

Product Dimensions (w x d x h)

11.8 x 8.8 x 0.83 in 30 x 20.53 x 2.12 cm

32. Weight will vary by configuration.

PORTS/SLOTS

Ports

2 USB 3.1 Gen 1 1 USB Type-C™ (Data transfer, power delivery) 1 HDMI 1.4b³³ 1 AC power 1 RJ-45 1 headphone/microphone combo jack

33. HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.34

34. HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.



Technical Specifications ENVIRONMENTAL & INDUSTRY

Environmental Data

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT® Silver registered in the United States. See http://www.epeat.net for registration status in your country.
- TCO Certified 8.0

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method)

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation	3.50 W	3.58 W	3.52 W	
(Sort idle)				
Normal Operation	1.30 W	1.26 W	1.30 W	
(Long idle)				
Sleep	0.29 W	0.31 W	0.29 W	
Off	0.24 W	0.26 W	0.24 W	

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	12 BTU/hr	12 BTU/hr	12 BTU/hr
Normal Operation (Long idle)	4 BTU/hr	4 BTU/hr	4 BTU/hr
Sleep	1 BTU/hr	1 BTU/hr	1 BTU/hr
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



Technical Specifications

Declared Noise Emissions (in accordance with	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
ISO 7779 and ISO 9296) Typically Configured – Idle	2.5	15
Fixed Disk – Random writes	2.5	14

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 3 USB ports
- 1 PC card slot (type I/II)
- 1 ExpressCard/54 slot
- 1 IEEE 1394 Port
- Optional expansion base docking station
- 1 multi-bay II storage port
- Interchangeable HDD

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <Silver> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 23% post-consumer recycled plastic (by wt.)
- This product is 96.1% recycle-able when properly disposed of at end of life

Packaging Materials	External:	PAPER/Corrugated	235 g
	Internal:	PLASTIC/Polypropylene - PP	3 g
		PLASTIC/Polyethylene Expanded - EPE	27 g
		PLASTIC/Polyethylene low density - LDPE	13 g



Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- · Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to:

http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a

responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This



information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product

_Design_ISO_14K_Certificate.pdf

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

SYSTEM UNIT

Stand-Alone Power Requirements (AC

Power)

Nominal Operating Voltage 19V

Average Operating Power Win 10

Integrated graphics Yes

Max Operating Power UMA<45W

Temperature

Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 240 G, 2 ms, half-sine

Random Vibration

Operating 0.75 grms Non-operating 1.50 grms

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry Standard

Certifications

UL Yes
CSA Yes
FCC Compliance Yes
ENERGY STAR® Yes³⁶



Technical Specifications

EPEAT® 2019 Yes, Silver in U.S.³⁷

ICES Yes Australia Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes SABS Yes

36. Configurations of the HP ProBook x360 11 G5 EE is ENERGY STAR® qualified are identified as HP

ProBook x360 11 G5 EE ENERGY STAR on HP websites and on http://www.energystar.gov.

Yes

37. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country.

Visit http://www.epeat.net for more information.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 11.6 HD AG
WLED SVA 45% NTSC
220 nits eDP Slim

UKRSERTCOMPUTER

Outline Dimensions 278.5 x 168.5 mm (max)

 $(W \times H \times D)$

Active Area 256.125 x 144 mm

Weight210 g maxDiagonal Size11.6 (inches)Thickness3.0 mm (max)

Interface eDP1.2

Surface Treatment BrightView Glass

Touch Enabled Yes

Contrast Ratio 400:1 (typical)

Refresh Rate 60 Hz

Brightness 220 nit typical (panel only)

Pixel Resolution 1366 x 768 (HD)

Format of LCD Pixel Arrangement RGB Backlight LED



Color Gamut Coverage 45% of NTSC

Color Depth 6 bits

Viewing Angle SVA 45/45/15/35

Panel LCD 11.6 inch HD AG WLED UWVA 50% NTSC 220 nits eDP slim **Outline Dimensions** 278.5 x 168.5 mm (max)

(W x H x D)

Active Area 256.125 x 144 mm

Weight 200 g max

Diagonal Size 11.6 (inches)

Thickness 3.2 mm max
Interface eDP1.2

Surface Treatment BrightView Glass

Touch Enabled Yes

Contrast Ratio 800:1 (typical)

Refresh Rate 60 Hz

Brightness 220 nit typical (panel only)

Pixel Resolution 1366 x 768 (HD)

Format of LCD Pixel Arrangement RGB Backlight LED

Color Gamut Coverage 50% of NTSC

Color Depth 6 bits

Viewing Angle UWVA 85/85/85

STORAGE AND DRIVES

eMMC 64 GB MO-276 MMCv5.0 Drive Weight 0.2 Height 1.4 mm

Width 11.5 x 13 mm Interface MMC potocal

Seek Time Sequential Read Sequential Write

Up to 250 MB/s Up to 70 MB/s

Logical Blocks 32 GB(31,268,536,320 Bytes)/64 GB(62,537,072,640 Bytes)

Operating Temperature 0 to 70 **Security Features** HS400

128 GB 2280 M2 SATA-3 TLC Solid State Drive Form Factor M.2 2280
Capacity 128 GB
NAND Type TLC



Technical Specifications

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 ATA-8, SATA 3.0

 Seek Time
 Seguential Read

Sequential Read Sequential Write

Up To 520 MB/s Up To 450 MB/s

Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

256 GB 2280 M2 SATA-3 TLC Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Seek Time Sequential Read Sequential Write

Up To 540 MB/s Up To 515 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

NETWORKING/COMMUNICATIONS

Intel® 9560 Wireless LAN IEEE 802.11a
802.11a/b/g/n/ac (2x2) Standards IEEE 802.11b
WiFi and Bluetooth® 5.0 IEEE 802.11g
Combo¹ non-vPro IEEE 802.11a

IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11t
IEEE 802.11r
IEEE 802.11v
Wi-Fi® certified

Interoperability Wi-Fi® certified Frequency Band •802.11b/g/n

2.402 – 2.482 GHz •802.11a/n/ac

4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz



Technical Specifications

5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

•IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode

only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification
•IEEE 802.11i

•WAPI

Network Ad-hoc (Peer to Peer)

Architecture Models

Roaming

Infrastructure (Access Point Required)

Output Power²

IEEE 802.11 compliant roaming between access points

802.11b: +18.5dBm minimum
802.11g: +17.5dBm minimum
802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

• 802.11ac VHT160(5GHz) : +11.5dBm minimum

Power Consumption • Transmit mode 2.0 W

•Receive mode 1.6 W

•Idle mode (PSP) 180 mW (WLAN Associated)
•Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW
 Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum

802.11ac, MCS0: -84dBm maximum



802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card

to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate¹ 2.17 Mbps

BLE: 1 Mbps signaling data rate¹ 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps,

voice channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1

kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth

device with a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Bluetooth Software Supported Microsoft Windows Bluetooth Software

Link Topology

Power Management Microsoft Windows ACPI, and USB Bus Support



Technical Specifications

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power ManagementETS 300 328, ETS 300 826CertificationsLow Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Intel® Wi-Fi 6 AX200 + Bluetooth 5 (802.11ax 2x2, non-vPro, supporting gigabit file transfer speeds) non-vPro Wireless LAN Standards IEEE 802.11a

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h

IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

InteroperabilityWi-Fi® certifiedFrequency Band•802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz

5.825 – 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz



Technical Specifications

& 160MHz)

• 802.11ax : MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz,

80MHz & 160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security³ •IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/q

mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification •IEEE 802.11i

•WAPI

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
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802.11ac VHT80(5GHz): +11.5dBm minimum

802.11ac VHT160(5GHz): +11.5dBm minimum
 802.11ax HT40(2.4GHz): +10dBm minimum

• 802.11ax VHT160(5GHz) : +10dBm minimum

Power Consumption •Transmit mode: 2.0 W

•Receive mode: 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
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 Connected Standby/Modern Standby: 10mW

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 802.11n, MCS07: -67dBm maximum

• 802.11n, MCS15: -64dBm maximum

802.11ac, MCS0: -84dBm maximum
 802.11ac, MCS9: -59dBm maximum

•802.11ax, MCS11(HT40): -59dBm maximum

•802.11ax, MCS11(VHT160): -58.5dBm maximum



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voice channels

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Link Topology

Power Management Microsoft Windows ACPI, and USB Bus Support



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Power Management ETS 300 328, ETS 300 826 **Certifications** Low Voltage Directive IEC950

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LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)



POWER

HP 45 W Smart AC adapter **Dimensions** (H x W x D) 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)

Weight 0.386 lb (175 g) max

Not including power cord. Power cord varies by country

Input 90 to 265 VAC

Input Efficiency 87.74% at 115Vac and 88.4% at 230Vac

Input frequency range 47 to 63 Hz
Input AC current 1.4 A at 90 VAC

Output Output power 45 W

DC output 19.5 V

Hold-up time 5ms at 115 VAC input

Output current protection <8.0A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 32° to 95° F (0° to 35° C)

temperature

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class

B, CISPR22 Class B, CCC, NOM-1 NYCE.

MTBF - over 200,000 hours at 25°C ambient condition.

HP 65 W EM Smart AC adapter

 Dimensions
 102 x 55 x 30 mm

 Weight
 270 g +/- 10 g

Not including power cord. Power cord varies by country

Input Input Efficiency 87% min at 115V/230V

Input frequency range 47 to 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

Output DC output 65W(19.5V/3.33A)

Hold-up time 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 0° to 35° C

temperature

Non-operating (storage) -20° to 85° C

temperature

Altitude 0 to 5,000 m



Humidity 0% to 95% Storage Humidity 0% to 95%

EMI and Safety Certifications

CE Mark - EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability - failure rate of less than 0.1% annually within the first three

years of operation.

HP 45 W USB type C Straight 1.8 m AC Adapter **Dimensions** 94.0mm x 40.0mm x 26.5 mm

Weight 192.5 g +/-10%

Not including power cord. Power cord varies by country

Input Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%

Input frequency range 47 ~ 63Hz

Input AC current Max. 1.4 A at 90 Vac

Output Output power 5V/15W

9V/27W 12V/36W 15V/45W

DC output 5V/9V/12V/15V **Hold-up time** 5ms at 115 Vac input

Output current limit <5.0A

Connector USB Type-C

Environmental Design Operating 32°F to 95° F (0° to 35° C)

temperature

Non-operating (storage) 4°F to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class

B, CISPR22 Class B, CCC, NOM-1 NYCE.

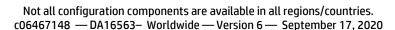
MTBF - over 200,000 hours at 25°C ambient condition.

HP 3-cell Long Life Li-Ion (48 WHr) Dimensions (H x W x L)

7.3 x 94 x 184.47 mm (0.287 x 3.7 x 7.263 inch)

Weight 0.215 kg

Cells/Type 3cell Lithium-Ion Prismatic cell / 596080 3cell Lithium-Ion Polymer cell / 606072





Technical Specifications

Voltage 11.4 V Amp-hour capacity 4.212Ah Watt-hour capacity 48Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

No

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

Type Cases	Description HP Essential Top Load Case (up to 15.6") HP Essential Backpack (up to 15.6") HP Slim Ultrabook Top Load (up to 15.6" x .88"/22/5mm) HP Slim Ultrabook Backpack (up to 15.6" x .88"/22/5mm) HP Black 11.6 Always On Case HP Slim Ultrabook Messenger	Part Number H2W17AA H1D24AA F3W15AA F3W16AA 2MY57AA F3W14AA
Docking	HP USB-C/A universal Dock G2	5TW13AA
Input/Output	HP Comfort Grip Wireless Mouse HP Slim USB Keyboard & Mouse Bundle HP 3-Button Laser Mouse HP USB Premium Mouse HP Wireless Premium Mouse HP Essential USB Mouse HP USB Travel Mouse HP Slim Bluetooth Mouse HP Slim Wireless keyboard and mouse HP USB-C to USB 3.0 Adapter HP USB-C to 3 and 4.5mm Adapter HP HDMI to VGA Adapter HP Pro Pen with Spare Tips HP Pro Pen Nib Set	H2L63AA T6T83AA H4B81AA 1JR32AA 1JR31AA 2TX37AA G1K28AA F3J92AA T6L04AA N2Z63AA N2Z63AA H4F02AA TBD
Power	HP 45W Smart AC Adapter (4.5mm) HP 65W Smart AC Adapter (4.5mm) HP 45W LC USB-C Power Adapter HP Notebook Powerbank HP USB-C ESSENTIAL POWER BANK HP USB-C Notebook Power Bank	H6Y88AA H6Y89AA 1MZ01AA N9F71AA 3TB55AA 2NA10AA
Storage	HP External USB Optical Drive	F2B56AA
Security	HP Nano Keyed Cable Lock	1AJ39AA
UCC	HP Stereo USB Headset HP Stereo 3.5mm Headset	T1A67AA T1A66AA

^{*}Supported using the USB connection for video and data. Power is not supported and must be provided directly to the Notebook with the power adapter that comes with the unit



Summary of Changes

Date of change:	Version History:		Description of change:
February 28, 2020	V1 to V2	Added	Environmental Section
May 13, 2020	V2 to V3	Updated	Military Standards information and removed old docking stations.
June 25, 2020	V3 to V4	Updated	HDMI port
July 07, 2020	V4 to V5	Updated	Accessories section
September 17, 2020	V5 to V6	Removed	HP USB-C/A universal Dock G2

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